

2SK2903-01MR

FUJI POWER MOS-FET

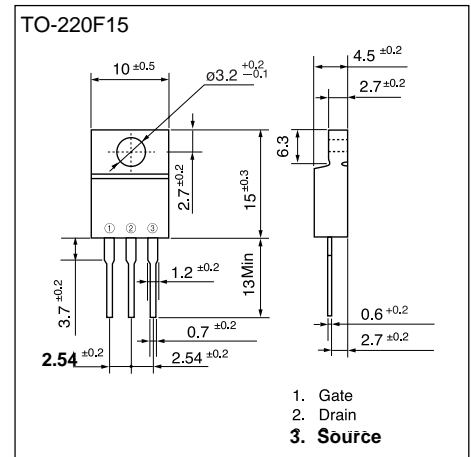
N-CHANNEL SILICON POWER MOS-FET

■ Features

- High speed switching
- Low on-resistance
- No secondary breakdown
- Low driving power
- Avalanche-proof

■ Applications

- Switching regulators
- UPS (Uninterruptible Power Supply)
- DC-DC converters



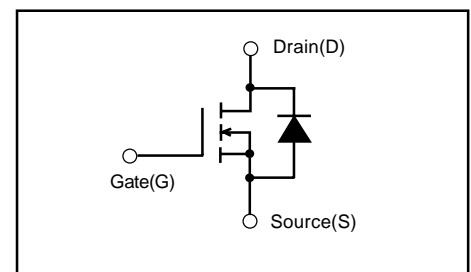
■ Maximum ratings and characteristic Absolute maximum ratings

● (T_c=25°C unless otherwise specified)

Item	Symbol	Rating	Unit
Drain-source voltage	V _{DS}	60	V
Continuous drain current	I _D	±50	A
Pulsed drain current	I _{D(puls)}	±200	A
Gate-source voltage	V _{GS}	±30	V
Maximum Avalanche Energy	E _{AV} *1	720.8	mJ
Max. power dissipation	P _D	50	W
Operating and storage temperature range	T _{ch} T _{stg}	+150 -55 to +150	°C

*1 L=0.384mH, V_{cc}=24V

■ Equivalent circuit schematic



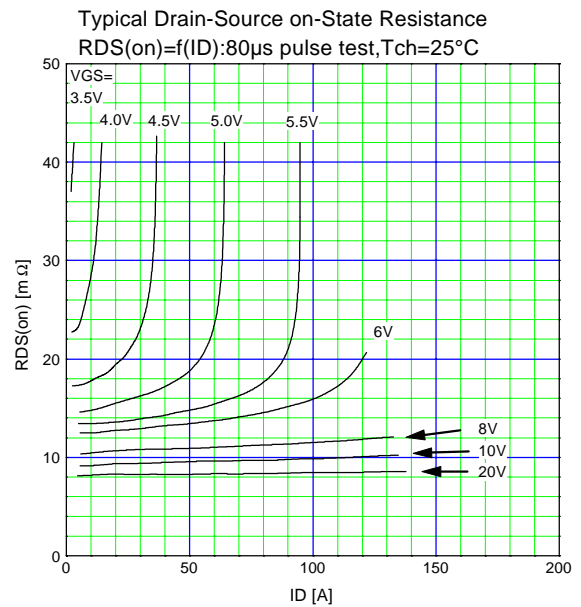
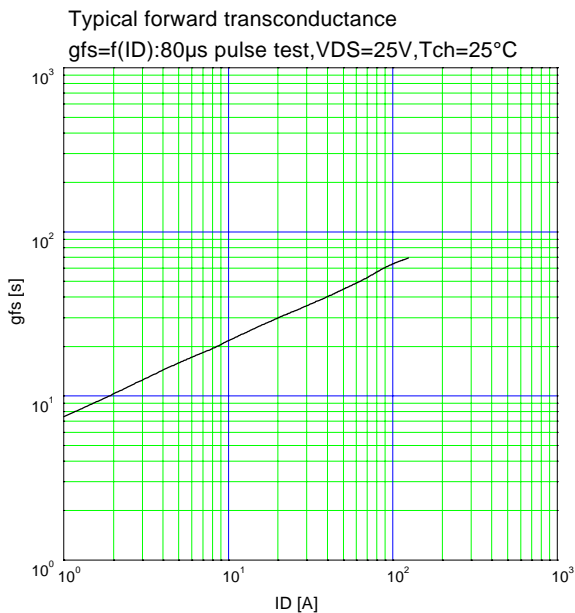
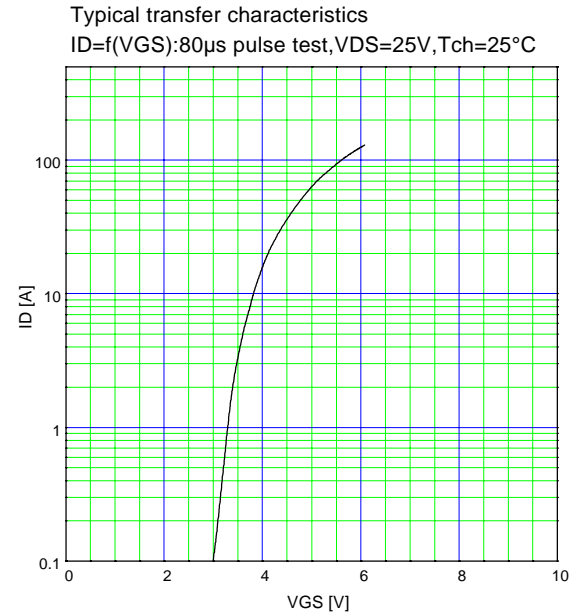
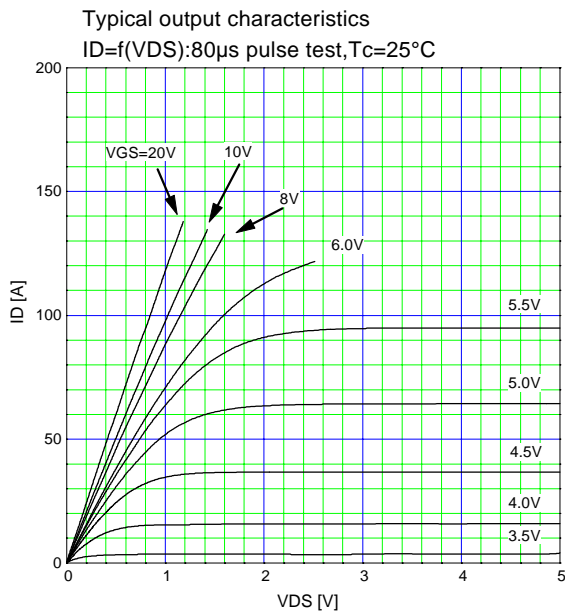
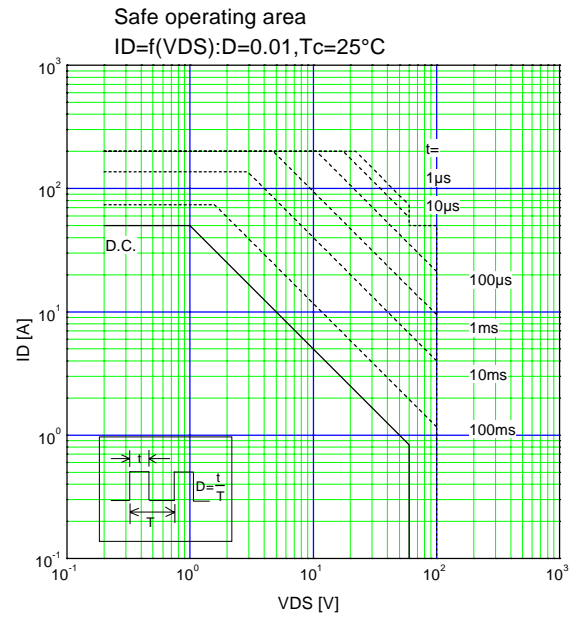
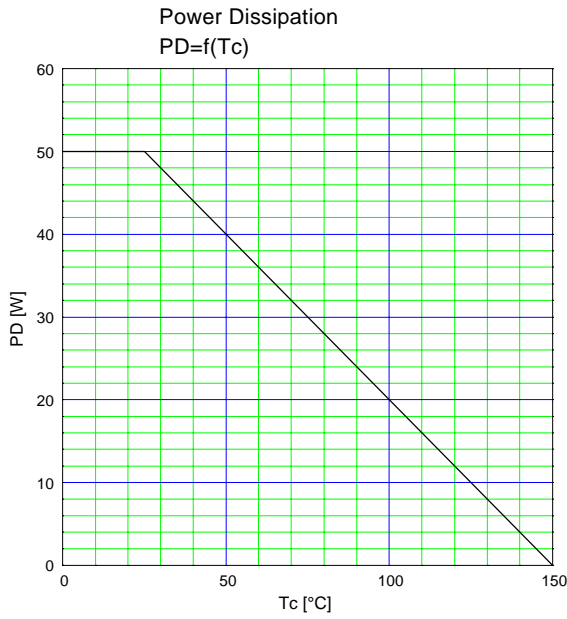
● Electrical characteristics (T_c = 25°C unless otherwise specified)

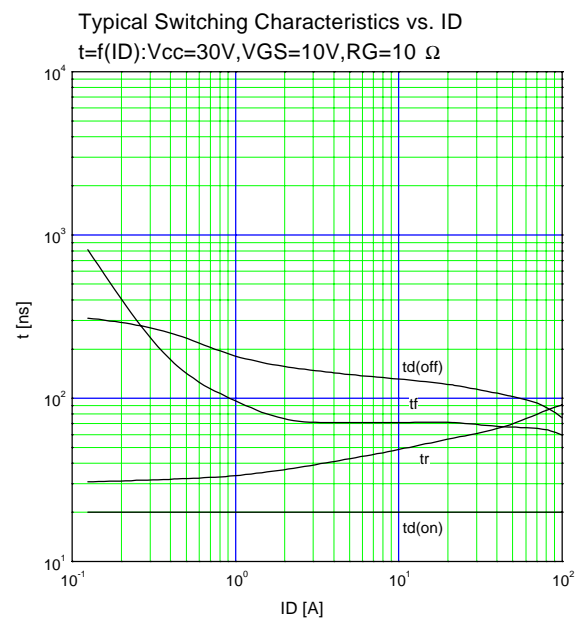
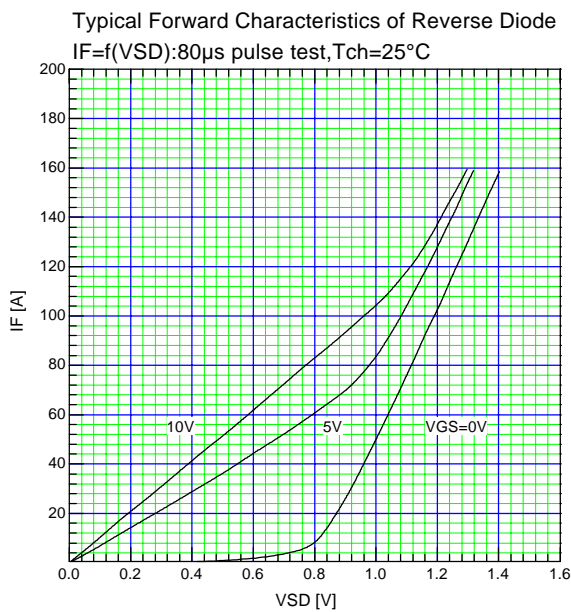
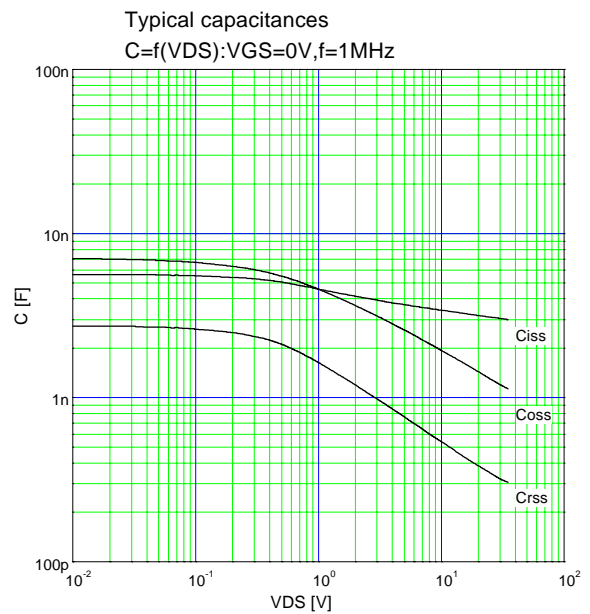
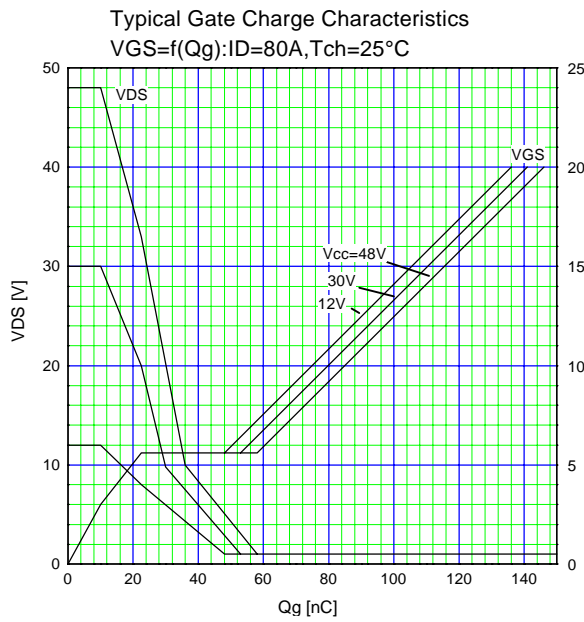
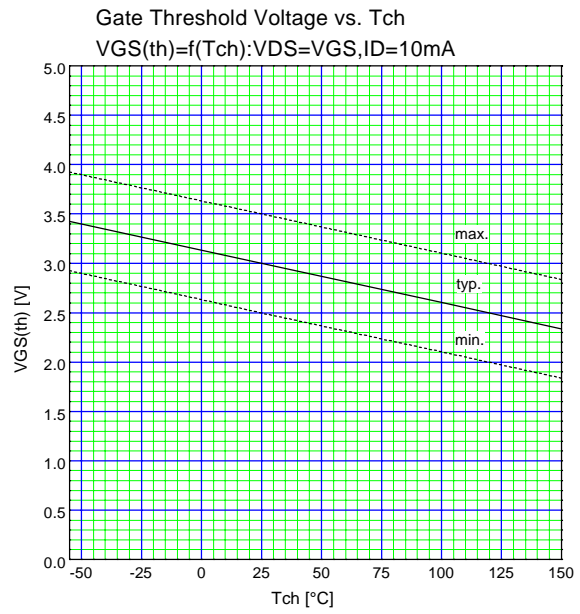
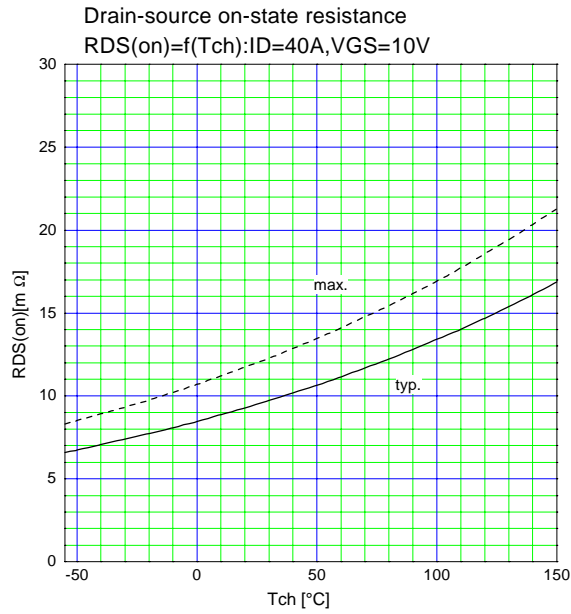
Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units	
Drain-source breakdown voltage	BV _{DSS}	I _D =1mA V _{GS} =0V	60			V	
Gate threshold voltage	V _{GS(th)}	I _D =10mA V _{DS} =V _{GS}	2.5	3.0	3.5	V	
Zero gate voltage drain current	I _{DSS}	V _{DS} =60V V _{GS} =0V	T _{ch} =25°C		10	500	μA
			T _{ch} =125°C		0.2	1.0	mA
Gate-source leakage current	I _{GSS}	V _{GS} =±30V V _{DS} =0V		10	100	nA	
Drain-source on-state resistance	R _{DS(on)}	I _D =40A V _{GS} =10V		9.5	12	mΩ	
Forward transconductance	g _{fs}	I _D =40A V _{DS} =25V	20	40		S	
Input capacitance	C _{iss}	V _{DS} =25V		3100	4650	pF	
Output capacitance	C _{oss}	V _{GS} =0V		1300	1950	pF	
Reverse transfer capacitance	C _{rss}	f=1MHz		350	530	pF	
Turn-on time t _{on}	td(on)	V _{CC} =30V I _D =80A V _{GS} =10V		20	30	ns	
	t _r			85	120		
	td(off)		R _{GS} =10Ω		88		130
Turn-off time t _{off}	t _f			65	120		
Avalanche capability	I _{AV}	L=100μH T _{ch} =25°C	50			A	
Diode forward on-voltage	V _{SD}	I _F =50A V _{GS} =0V T _{ch} =25°C		1.0	1.5	V	
Reverse recovery time	t _{rr}	I _F =50A V _{GS} =0V		70		ns	
Reverse recovery charge	Q _{rr}	-di/dt=100A/μs T _{ch} =25°C		0.13		μC	

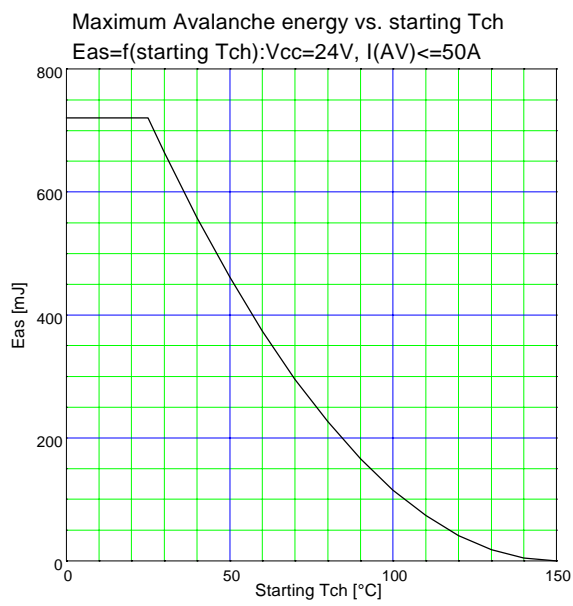
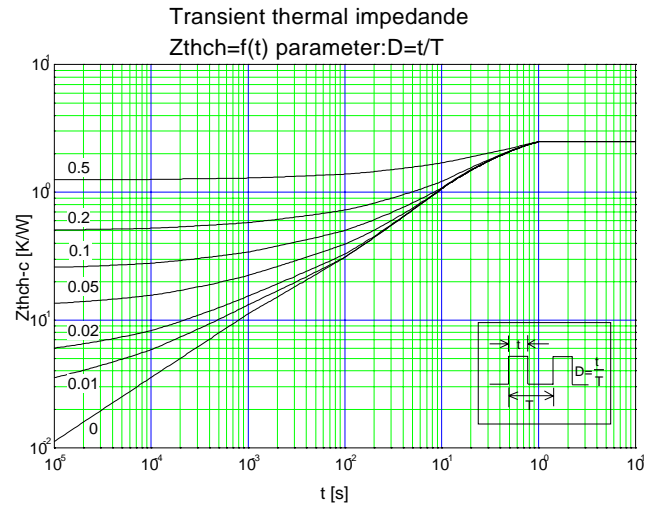
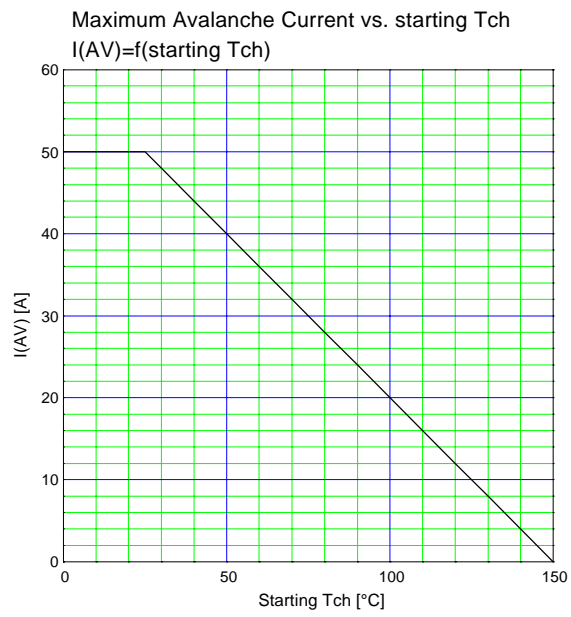
● Thermal characteristics

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal resistance	R _{th(ch-c)}	channel to case			2.5	°C/W
	R _{th(ch-a)}	channel to ambient			62.5	°C/W

Characteristics







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Datasheets for electronic components.